DELIVERY SPECIFICATION

SPEC. No. C2020-FA150

D A T E : 2020 April

To

Non-Controlled Copy

CUSTOMER'S PRODUCT NAME	TDK'S PRODUCT NAME Multilayer Ceramic Capacitors Dipped Radial Lead Type FA-Series High Temperature Application 【Halogen-free, RoHS compliant】

Please return this specification to TDK representatives with your signature.
If orders are placed without returned specification, please allow us to judge that specification is accepted by your side.

RECEIPT CONFIRMATION

DATE: YEAR MONTH DAY

TDK Corporation

Sales
Electronic Components
Sales & Marketing Group

Engineering
Electronic Components Business Company
Ceramic Capacitors Business Group

APPROVED	Person in charge

APPROVED	CHECKED	Person in charge

SCOPE

This delivery specification shall be applied to Multilayer ceramic chip capacitors to be delivered to _____.

PRODUCTION PLACES

Production places defined in this specification shall be TDK Xiamen Co., (China).

PRODUCT NAME

The name of the product to be defined in this specifications shall be FA〇〇△△△□□□×××◎＊＊＊＊.

REFERENCE STANDARD

JIS	C 5101-1	Fixed capacitors for use in electronic equipment-Part 1 : Generic specification
	C 0806-2	Packaging of components for automatic handing-Part 2 : Packaging of components with unidirectional leads on continuous tapes
JEITA	RCR-2335 C	Safety application guide for fixed ceramic capacitors for use in electronic equipment

CONTENTS

<EXPLANATORY NOTE>

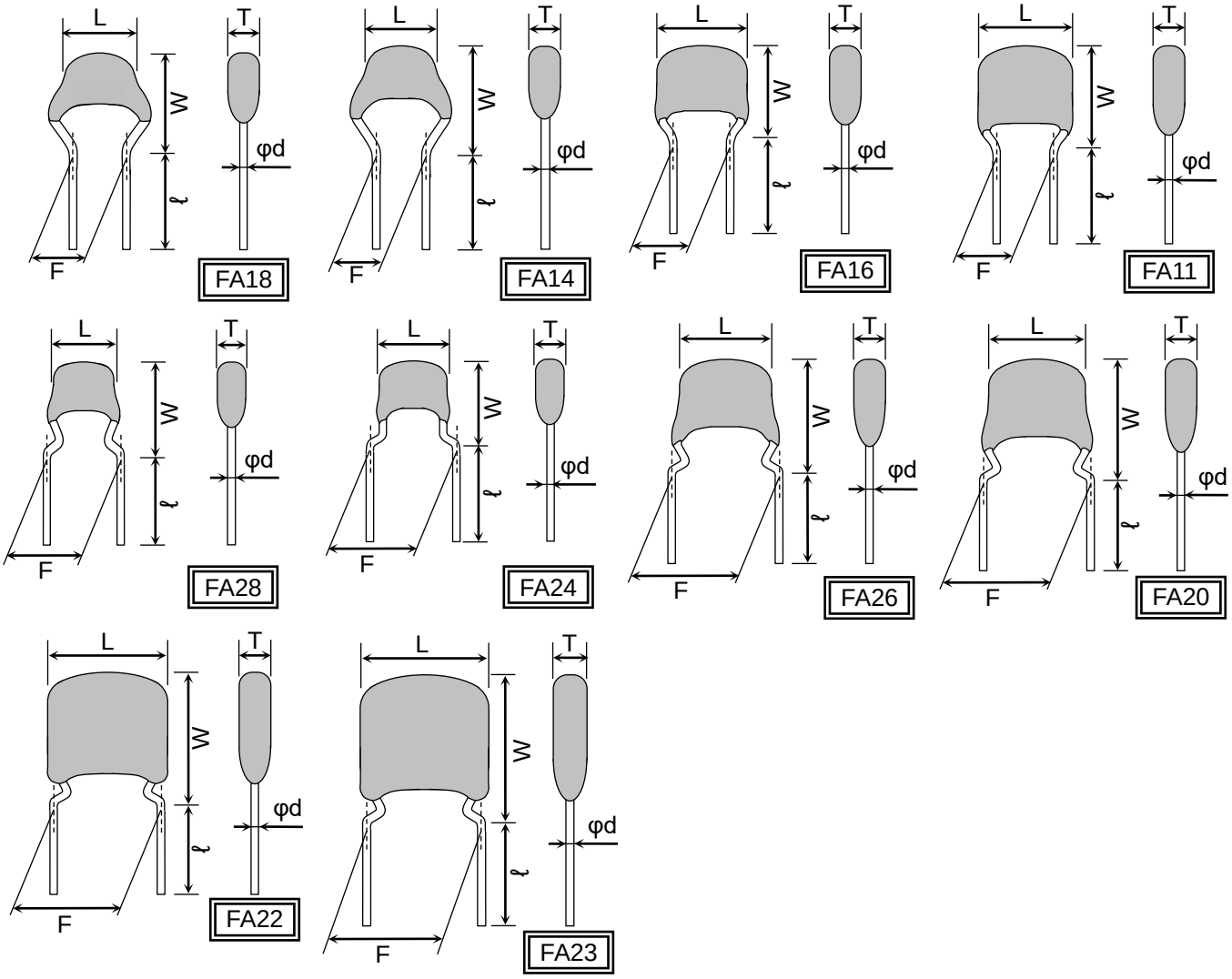
When the mistrust in the spec arises, this specification is given priority. And it will be confirmed by written spec change after conference of both posts involved.
This specification warrants the quality of the ceramic chip capacitor. Capacitors should be evaluated or confirmed a state of mounted on your product.
If the use of the capacitors goes beyond the bounds of this specification, we can not afford to guarantee.

Division	Date	SPEC. No.
Ceramic Capacitors Business Group	Apr., 2020	C2020-FA150

1. CODE CONSTRUCTION

(Example) FA28 (1) X8R (2) 1H (3) 104 (4) K (5) NU0 (6) 6 (7)

(1) Case size



Case size *1	Dimensions (mm)					
	L(max.) *2	W(max.)	T(max.)	F *3	ℓ *3	φd
FA18	4.0	5.5	2.5	2.5±0.8	7.0±2.0	0.5 +0.10 -0.03
FA14	4.5	5.5	3.0			
FA16	5.5	6.0	3.5			
FA11	5.5	7.0	4.0			
FA28	4.0	5.5	2.5	5.0±1.0	7.0±2.0	0.5 +0.10 -0.03
FA24	4.5	5.5	3.0			
FA26	5.5	6.0	3.5			
FA20	5.5	7.0	4.0			
FA22	7.5	8.5	4.5			
FA23	8.5	11.0	5.5			

*1 FA denotes forming lead.
The first digit refers to a distance between leads (1:2.5mm, 2:5.0mm),the second digit is for TDK internal code.
*2 The FA18, FA14, FA28 and FA24 types represent dimensions 1 mm below the top of the body.
Other types represent the dimensions of the central part of the body.
*3 Dimension F and ℓ is applied to bulk packaging.
The measurement point of F dimensions is 1.5 to 2.0mm below the kink.
Refer to Appendix 2 and 3 for dimension of taping packaging.

(2) Temperature Characteristics (Details are shown in para 6 No.7,8)

(3) Rated Voltage

Symbol	Rated Voltage
2 J	DC 630 V
2 W	DC 450 V
2 E	DC 250 V
2 A	DC 100 V
1 H	DC 50 V
1 E	DC 25 V

(4) Rated Capacitance

Stated in three digits and in units of pico farads (pF). The first and second digits identify the first and second significant figures of the capacitance, the third digit identifies the multiplier.

(Example)

Symbol	Rated Capacitance
104	100,000pF

(5) Capacitance tolerance

Symbol	Tolerance	Capacitance(C)
D	±0.5 pF	C=10pF
J	± 5 %	Over 10pF
K	±10 %	

(6) Internal code

Symbol	Applied voltage of Life
NU0	Rated voltage ×2 (*1)
RU0	Rated voltage ×1

*1 2E : Rated voltage×1.5
2W : Rated voltage×1.2
2J : Rated voltage×1.2

(7) Packaging

Symbol	Packaging
0	Bulk
6	Ammo Pack

2. COMBINATION OF RATED CAPACITANCE AND TOLERANCE

Class	Temperature Characteristics	Capacitance tolerance		Rated capacitance(C)
1	NP0	C＝10	D (±0.5 pF)	10
		10＜C≦100	J (± 5 %)	E- 6 series
		100＜C≦10,000	J (± 5 %)	E-12 series
		10,000＜C	J (± 5 %)	E- 6 series
2	X8R	C≦10	K (±10 %)	E- 6 series

Capacitance Step in E series

E series	Capacitance Step											
E- 6	1.0		1.5		2.2		3.3		4.7		6.8	
E-12	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2

3. OPERATING TEMPERATURE RANGE

T.C.	Min. operating Temperature	Max. operating Temperature	Reference Temperature
NP0 X8R	-55°C	150°C	25°C

4. STORING CONDITION AND TERM

Storing temperature	Storing humidity	Storing term
5~40°C	20~70%RH	Within 6 months upon receipt.

5. INDUSTRIAL WASTE DISPOSAL

Dispose this product as industrial waste in accordance with the industrial Waste Law.

7. PERFORMANCE

table 1

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Performance</th><th>Test or inspection method</th></tr>
<tr><td>1</td><td colspan="2">External Appearance</td><td>No defects which may affect performance.</td><td>By visual checking.</td></tr>
<tr><td rowspan="2">2</td><td rowspan="2">Indication</td><td>Appearance</td><td>Meet a requirement per para 8.</td><td rowspan="2"><table><tr><th>solvent</th><th>Solvent temp.</th><th>Dipping time</th></tr><tr><td>Isopropyl alcohol</td><td>20~25°C</td><td>30±5s.</td></tr></table></td></tr>
<tr><td>Resistance to solvent</td><td>Shall be visible.</td></tr>
<tr><td rowspan="2">3</td><td rowspan="2">Voltage Proof</td><td>Between termination</td><td>No insulation breakdown or other damage.</td><td><table><tr><th>Class</th><th>Rated voltage</th><th>Apply voltage</th></tr><tr><td rowspan="2">1</td><td>100V and under</td><td>3 × rated voltage</td></tr><tr><td>Over 100V</td><td>1.5 × rated voltage</td></tr><tr><td rowspan="2">2</td><td>RV≦100V</td><td>2.5 × rated voltage</td></tr><tr><td>Over 100V</td><td>1.5 × rated voltage</td></tr></table>Above DC voltage shall be applied for 1~5s.

Charge / discharge current shall not exceed 50mA.</td></tr>
<tr><td>Between termination coating</td><td>No insulation breakdown or other damage.</td><td>Apply ×2.5 rated voltage.
(By metallic small ball method.)</td></tr>
<tr><td>4</td><td colspan="2">Insulation Resistance</td><td>10,000MΩ or 500 MΩ・μF min. whichever smaller.</td><td>≪450V DC and under≫
Apply rated voltage.
≪630V DC≫
Apply DC500V.
Applying time : 60sec.</td></tr>
<tr><td>5</td><td colspan="2">Capacitance</td><td>Within the specified tolerance.</td><td>Class 1<table><tr><th>Rated capacitance</th><th>Measuring frequency</th><th>Measuring voltage</th></tr><tr><td>1,000pF and under</td><td>1MHz±10%</td><td rowspan="2">0.5~5 Vrms.</td></tr><tr><td>Over 1,000pF</td><td>1kHz±10%</td></tr></table>Class 2<table><tr><th>Rated capacitance</th><th>Measuring frequency</th><th>Measuring voltage</th></tr><tr><td>10μF and under</td><td>1kHz±10%</td><td>1.0±0.2 Vrms.</td></tr></table>For information which product has which measuring voltage, please contact with our sales representative.</td></tr>
</table>

(continued)

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Performance</th><th>Test or inspection method</th></tr>
<tr><td rowspan="2">6</td><td colspan="2">Q
(Class 1)</td><td>
<table>
<tr><th>Capacitance</th><th>Q</th></tr>
<tr><td>30pF and over</td><td>1,000 min.</td></tr>
<tr><td>Under 30pF</td><td>400+20×C min.</td></tr>
</table>
C : Rated capacitance (pF)
</td><td rowspan="2">See No.5 in this table for measuring condition.

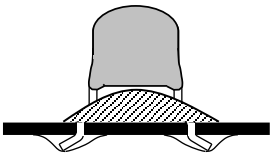
For information which product has which Dissipation Factor, please contact with our sales representative.</td></tr>
<tr><td colspan="2">Dissipation Factor
(Class 2)</td><td>
<table>
<tr><th>T.C.</th><th>D.F.</th></tr>
<tr><td>X8R</td><td>0.03 max.</td></tr>
</table>
</td></tr>
<tr><td>7</td><td colspan="2">Temperature Characteristics of Capacitance
(Class 1)</td><td>
<table>
<tr><th>Temperature Coefficient (ppm/°C)</th></tr>
<tr><td>NP0 : 0 ± 30</td></tr>
</table>
Capacitance drift
Within ±0.2% or ±0.05pF, whichever larger.
</td><td>Temperature Coefficient shall be calculated based on values at 25°C and 85°C temperature.

Measuring temperature below 20°C shall be -10°C and -25°C</td></tr>
<tr><td>8</td><td colspan="2">Temperature Characteristics of Capacitance
(Class 2)</td><td>
<table>
<tr><th>Capacitance Change(%)</th></tr>
<tr><td>No voltage applied</td></tr>
<tr><td>X8R : ±15</td></tr>
</table>
</td><td>Capacitance shall be measured by the steps shown in the following table, after thermal equilibrium is obtained for each step.
ΔC be calculated ref. STEP3 reading.
<table>
<tr><th>Step</th><th>Temperature(°C)</th></tr>
<tr><td>1</td><td>Reference temp. ±2</td></tr>
<tr><td>2</td><td>Min. operating temp. ±2</td></tr>
<tr><td>3</td><td>Reference temp. ±2</td></tr>
<tr><td>4</td><td>Max. operating temp. ±2</td></tr>
</table>
</td></tr>
<tr><td rowspan="2">9</td><td rowspan="2">Lead Strength</td><td>Tensile Strength</td><td>No mechanical damage such as lead breakage and loosing.</td><td>With holding the parts, apply pulling force to lead drawing direction gradually.
Pulling strength : 10N
Holding time : 10±1s.</td></tr>
<tr><td>Bending Strength</td><td>No mechanical damage such as lead breakage and loosing.</td><td>With holding the capacitors to keep the axis vertical, bend it 90 degrees with weighting and put it back to the original position.
This operation shall be done for 2~3s. and repeat the following times.
Bending forth : 5N
Testing time : 2 times</td></tr>
</table>

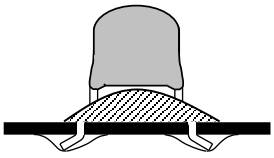
(continued)

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Performance</th><th>Test or inspection method</th></tr>
<tr><td>10</td><td>Mechanical Shock</td><td>External appearance</td><td>No mechanical damage.</td><td rowspan="4">With following conditions.

Waveform : Half-sine
Applied force : 100G max.
Velocity change : 12.3ft/s.
Duration : 6 msec.
Shocks : 18shocks in each 3 mutually perpendicular axes.

Solder the capacitors on a P.C.Board shown in Appendix1 before testing. The FA23 type fixes the capacitors with coating as follows.
  </td></tr>
<tr><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±2.5% or ±0.25pF, whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±7.5 %</td></tr></table></td></tr>
<tr><td></td><td>Q
Class1</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td>D.F.
Class2</td><td>Meet the initial spec.</td></tr>
<tr><td>11</td><td>Vibration</td><td>External appearance</td><td>No mechanical damage.</td><td rowspan="4">Vibrate the capacitor with following conditions.

Applied force : 5G max.
Frequency : 10-2,000-10Hz
Duration : 20 min.
Cycle : 12cycles in each 3 mutually perpendicular directions.

Solder the capacitors on a P.C.Board shown in Appendix1 before testing. The FA23 type fixes the capacitors with coating as follows.
  </td></tr>
<tr><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±2.5% or ±0.25pF, whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±7.5 %</td></tr></table></td></tr>
<tr><td></td><td>Q
Class1</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td>D.F.
Class2</td><td>Meet the initial spec.</td></tr>
<tr><td>12</td><td colspan="2">Solderability</td><td>Leads shall be covered by new solder more than 75% of its surface.</td><td>Completely soak both terminations in solder at 245±5°C for 2±0.5s.

Solder : Sn-3.0Ag-0.5Cu(Pb-free)
Flux : Isopropyl alcohol(JIS K 8839)
Rosin(JIS K 5902)
25% solid solution.
Dipping : By 1.5~2.0mm from the root of lead.</td></tr>
</table>

(continued)

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Performance</th><th>Test or inspection method</th></tr>
<tr><td>13</td><td>Resistance to solder heat</td><td>External appearance</td><td>No defects which may affect performance.</td><td rowspan="6">Completely soak both terminations in solder at 260±5°C for 10±1s.

Solder : Sn-3.0Ag-0.5Cu(Pb-free)
Flux : Isopropyl alcohol(JIS K 8839)
Rosin(JIS K 5902)
25% solid solution.
Dipping : By 1.5~2.0mm from the root of lead.

Leave the capacitors in ambient condition for the following time before measurement.

Class1 : 6~24h
Class2 : 24±2h</td></tr>
<tr><td></td><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±2.5 % or ±0.25pF whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±7.5 %</td></tr></table></td></tr>
<tr><td></td><td></td><td>Q
Class1</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>D.F.
Class2</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>Insulation Resistance</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>Voltage proof</td><td>No insulation breakdown or other damage.</td></tr>
<tr><td>14</td><td>Heat shock</td><td>External appearance</td><td>No mechanical damage.</td><td rowspan="6">Solder the capacitors on a P.C.Board shown in Appendix1 before testing.

Expose the capacitors in the condition step1 through 2.
<table><tr><th>Step</th><th>Temp.(°C)</th><th>Time(min.)</th></tr><tr><td>1</td><td>Min. operating Temp.±3</td><td>30 ± 3</td></tr><tr><td>2</td><td>Max. operating Temp.±2</td><td>30 ± 3</td></tr></table>Test cycle : 1,000cycles
Transit time : Less than 1min.

Leave the capacitors in ambient condition for the following time before measurement.

Class1 : 6~24h
Class2 : 24±2h</td></tr>
<tr><td></td><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±2.5 % or ±0.25pF whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±7.5 %</td></tr></table></td></tr>
<tr><td></td><td></td><td>Q
Class1</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>D.F
Class2</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>Insulation Resistance</td><td>Meet the initial spec.</td></tr>
<tr><td></td><td></td><td>Voltage proof</td><td>No insulation breakdown or other damage.</td></tr>
</table>

(continued)

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Performance</th><th>Test or inspection method</th></tr>
<tr><td>15</td><td>Moisture Resistance</td><td>External appearance</td><td>No mechanical damage.</td><td rowspan="5">Solder the capacitors on a P.C.Board shown in Appendix1 before testing.

Apply the rated voltage at temperature 85±2°C and 85%RH for 1,000 +48,0h.

Charge/discharge current shall not exceed 50mA.

Leave the capacitors in ambient condition for the following time before measurement.
Class1 : 6~24h
Class2 : 24±2h

Voltage conditioning : (Only Class2)
Voltage treat the capacitor under testing temperature and voltage for 1hour.
Leave the capacitors in ambient condition for 24±2h before measurement.

Use this measurement for initial value.</td></tr>
<tr><td></td><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±7.5% or ±0.75pF whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±12.5 %</td></tr></table></td></tr>
<tr><td></td><td></td><td>Q
Class1</td><td><table><tr><th>Capacitance</th><th>Q</th></tr><tr><td>30pF and over</td><td>200 min.</td></tr><tr><td>Under 30pF</td><td>100+10/3×C min.</td></tr></table>C : Rated capacitance (pF)</td></tr>
<tr><td></td><td></td><td>D.F.
Class2</td><td>200% of initial spec max.</td></tr>
<tr><td></td><td></td><td>Insulation Resistance</td><td>500MΩ or 25MΩ・μF min. whichever smaller.</td></tr>
<tr><td>16</td><td>Life</td><td>External appearance</td><td>No mechanical damage.</td><td rowspan="4">Solder the capacitors on a P.C.Board shown in Appendix1 before testing.

Below the voltage shall be applied at maximum operating temperature ±2°C for 1,000 +48,0h.
<table><tr><th>Applied voltage</th></tr><tr><td>Rated voltage x2</td></tr><tr><td>Rated voltage x1.5</td></tr><tr><td>Rated voltage x1.2</td></tr><tr><td>Rated voltage x1</td></tr></table>
For information which products has which applied voltage, please contact with our sales representative.

Charge/discharge current shall not exceed 50mA.

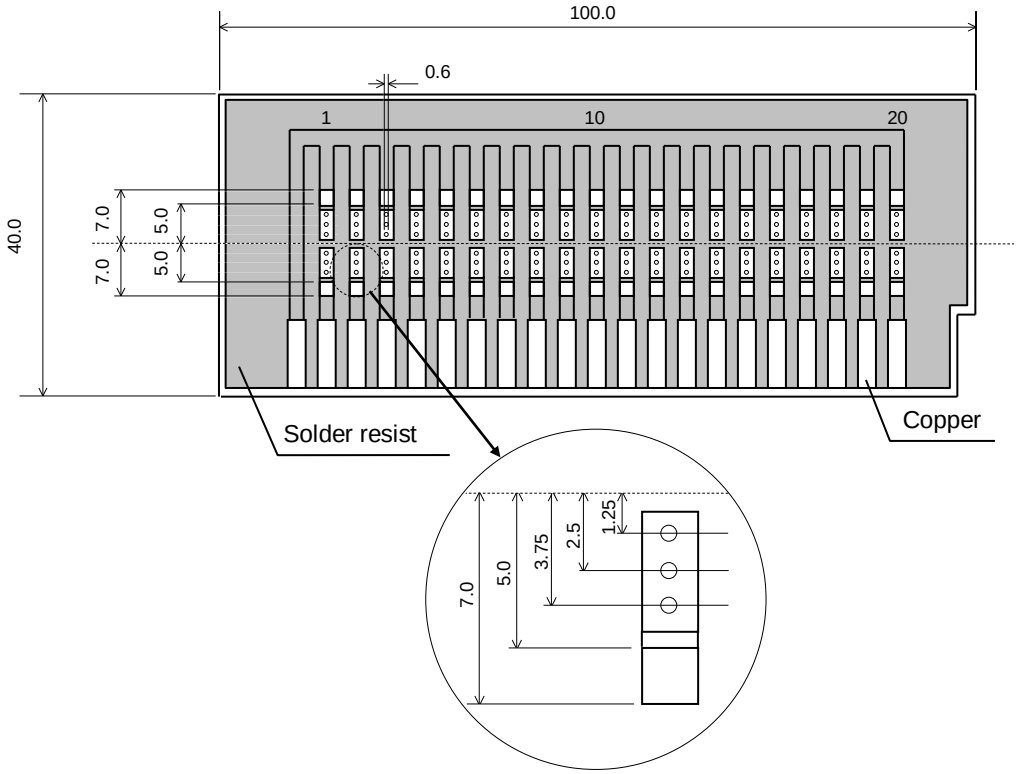
Leave the capacitors in ambient condition for the following time before measurement.
Class1 : 6~24h
Class2 : 24±2h

Voltage conditioning : (Only Class2)
Voltage treat the capacitor under testing temperature and voltage for 1hour.
Leave the capacitors in ambient condition for 24±2h before measurement.
Use this measurement for initial value.</td></tr>
<tr><td></td><td></td><td>Capacitance</td><td><table><tr><th colspan="2">Characteristics</th><th>Change from the value before test</th></tr><tr><td>Class 1</td><td>NP0</td><td>±3% or ±0.3pF whichever larger.</td></tr><tr><td>Class 2</td><td>X8R</td><td>±15 %</td></tr></table></td></tr>
<tr><td></td><td></td><td>Q
Class1</td><td><table><tr><th>Capacitance</th><th>Q</th></tr><tr><td>30pF and over</td><td>350 min.</td></tr><tr><td>10pF and over under 30pF</td><td>275+5/2×C min.</td></tr><tr><td>Under 10pF</td><td>200+10×C min.</td></tr></table>C : Rated capacitance (pF)</td></tr>
<tr><td></td><td></td><td>D.F.
Class2</td><td>200% of initial spec max.</td></tr>
</table>

* As for the initial measurement of capacitors (Class2) on number 8, 10, 11, 13, and 14, leave capacitors at 150 -10,0°C for 1h and measure the value after leaving capacitors for 24±2h in ambient condition.

Appendix1

P.C. board



(Unit : mm)

1. Material : Glass Epoxy(As per JIS C6484 GE4)

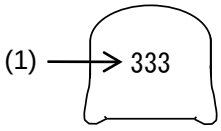
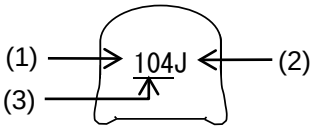
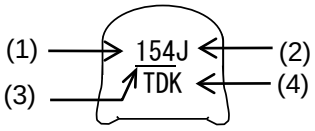
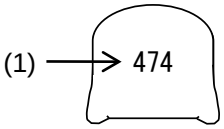
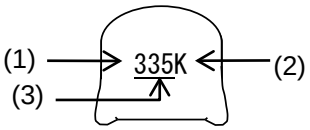
2. Thickness : 1.6mm

Copper(Thickness:0.035mm)

Solder resist

7. INDICATION

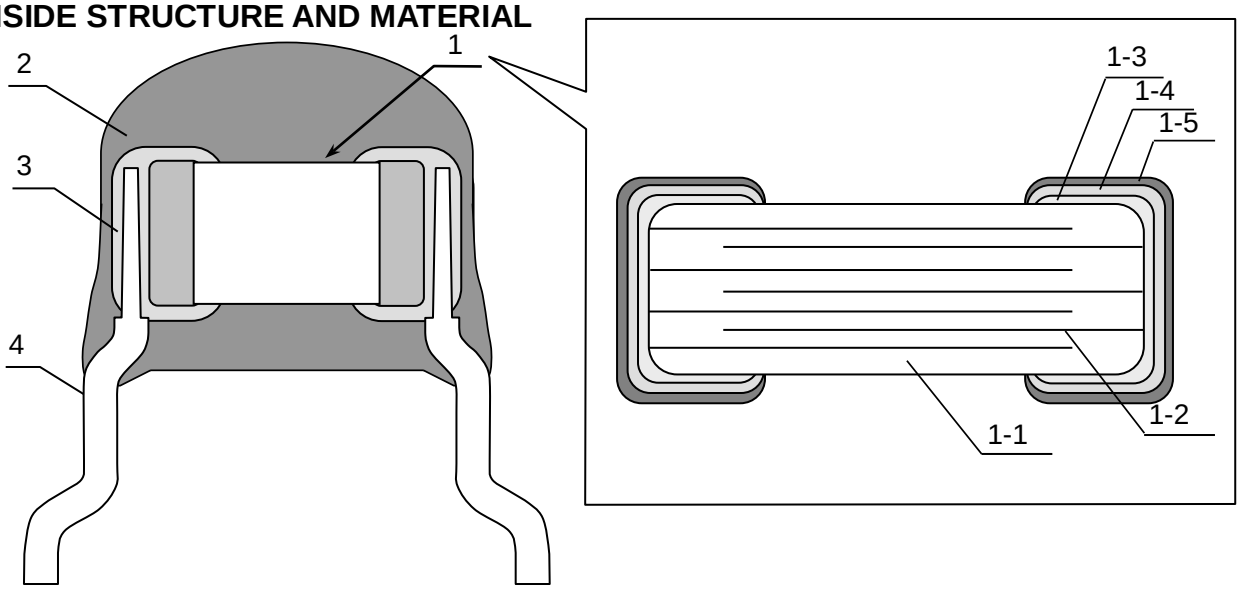
7.1 Indication (Example)

Type / T.C.	FA18 FA14 FA28 FA24	FA16 FA11 FA26 FA20	FA22 FA23
NP0			
X8R			——

7.2 Meaning of indication

No.	Item	Detail
(1)	Rated Capacitance	Indicate in three digits.
(2)	Capacitance tolerance	Indicates the symbol.
(3)	Rated voltage	For DC50V, indicate a bar under the rated capacitance.
(4)	Manufacturer	Indicates " TDK ".

8. INSIDE STRUCTURE AND MATERIAL



No.	NAME	No.	NAME	MATERIAL	
				Class 1	Class 2
1	Multilayer Ceramic Chip Capacitors	1-1	Dielectric	$CaZrO_3$	$BaTiO_3$
		1-2	Electrode	Ni	
		1-3	Termination	Cu	
		1-4		Ni	
		1-5		Sn	
2	Coating			Epoxy 【Halogen-free】	
3	Solder for joint			Lead free solder	
4	Lead wire			Tin plated copper covers steel wire	

9. PACKAGING

Packaging shall be done to protect the components from the damage during Transportation and storing, and a label which has the following information shall be attached.

1) Inspection No. *
2) TDK P/N
3) Quantity

* Composition of Inspection No.

Example X 0 A - OO - OOO
(a) (b) (c) (d) (e)

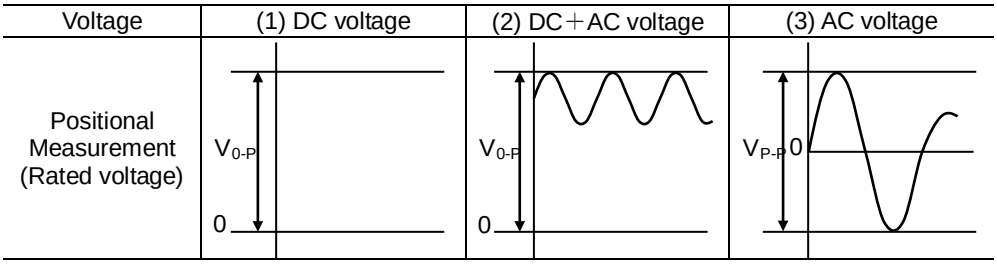
a) Inspection factory code
b) Last digit of year
c) Month and A for January and B for February and so on. (Skip I)
d) Inspection Date of the month.
e) Serial No. of the day

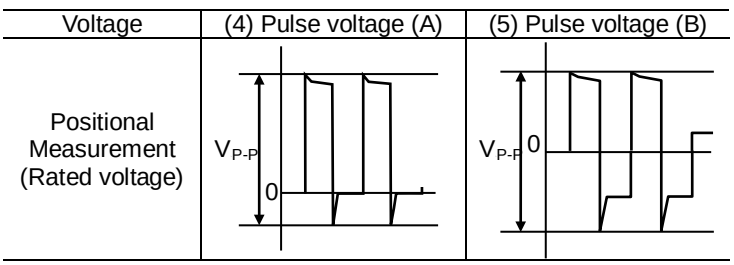
1) Total number of components in a plastic bag.

Type	Qty.(pcs.)
FA18, FA28 FA14, FA24 FA16, FA26 FA11, FA20 FA22	500
FA23	200

2) Tape packaging is as per TDK tape packaging specification.

10. CAUTION

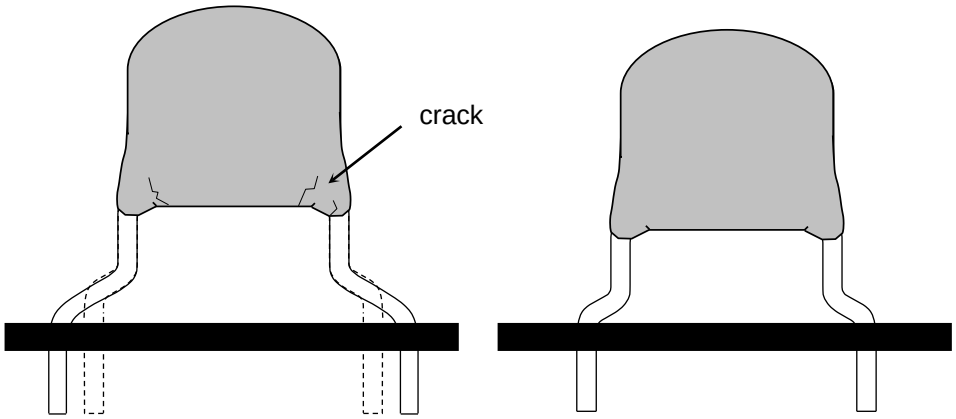
<table>
<tr><th>No.</th><th>Process</th><th>Condition</th></tr>
<tr><td>1</td><td>Operating Condition (Storage,Use, Transportation)</td><td>1-1. Storage,Use
1) The capacitor must be stored in an ambient temperature of 5~40°C with a relative humidity of 20~70%. The products should be used within 6 months upon receipt.
2) The capacitors must be operated and stored in an environment free of dew condensation and these gases such as Hydrogen Sulphide, Hydrogen Sulphate, Chlorine, Ammonia and sulfur.
3) Avoid storing in sun light and wet with dew.
4) Do not use capacitors under high humidity and high and low atmospheric pressure which may affect capacitors reliability.
5) Capacitors should be tested for the solderability when they are stored for long time.
1-2. Handling in transportation
1) In case of the transportation of the capacitors, the performance of the capacitors may be deteriorated depending on the transportation condition.
(Refer to JEITA RCR-2335C 9.2 Handling in transportation)</td></tr>
<tr><td>2</td><td>Circuit design
⚠ Caution</td><td>2-1. Operating temperature
Operating temperature should be followed strictly within this specification, especially be careful with the maximum temperature.
1) Do not use capacitor above the maximum allowable operating temperature.
2) Surface temperature including self heating should be below maximum operating temperature.
(Due to dielectric loss, capacitor will heat itself when AC is applied. Especially at high frequencies around its SRF, the heat might be so extreme that it may damage itself or the product mounted on. Please design the circuit so that the maximum temperature of the capacitor including the self heating to be below the maximum allowable operating temperature. Temperature rise shall be bellow 20°C.)
3) The electrical characteristics of the capacitors will vary depending on the temperature. The capacitors should be selected and designed in taking the temperature into consideration.
2-2. Operating voltage
1) Operating voltage across the terminals should be below the rated voltage.
When AC and DC are super imposed, V0-P must be below the rated voltage.
——— (1) and (2)
AC or pulse with overshooting, V_{P-P} must be below the rated voltage.
———(3), (4) and (5)
When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.
 

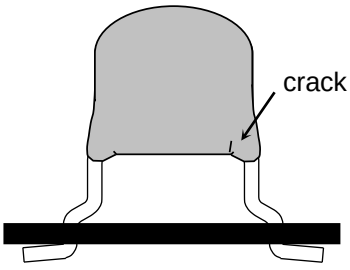
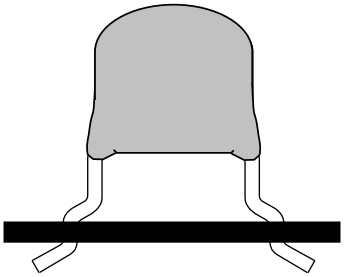

</td></tr>
</table>

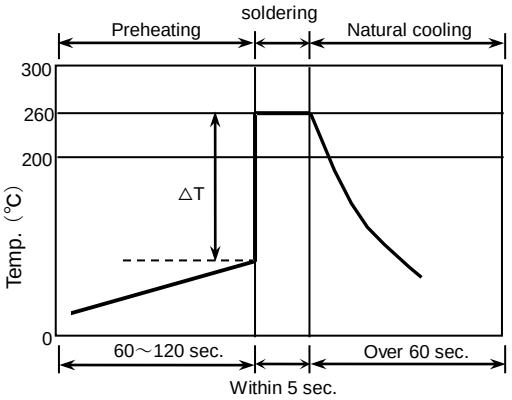
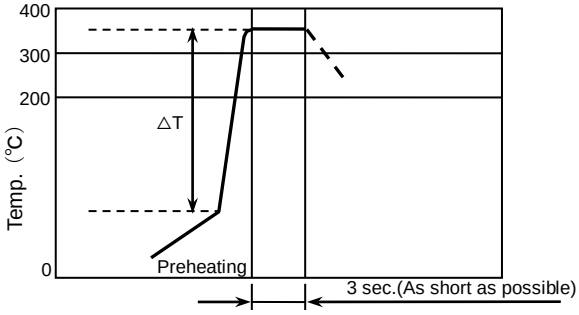
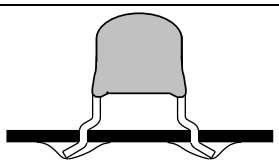
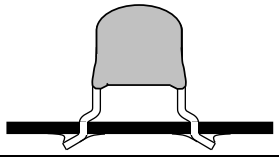
<table>
<tr><th>No.</th><th>Process</th><th>Condition</th></tr>
<tr><td>2</td><td>Circuit design
⚠ Caution</td><td>2) Even below the rated voltage, if repetitive high frequancy AC or pulse is applied, the reliability of the capacitor may be reduced.

3) The effective capacitance will vary depending on applied DC and AC voltages. The capacitors should be selected and designed in taking the voltages into consideration.

2-3. Frequency
1) When the capacitors (Class 2) are used in AC and/or pulse voltages, the capacitors may vibrate themselves and generate audible sound.</td></tr>
<tr><td>3</td><td>Designing P.C.board</td><td>If capacitor leads are inserted into different pitch holes, it may induce excessive stress in the capacitor or outer resin to result in cracking, and it may degrade the quality.
Recommend capacitor layout is as following.

Not recommended Recommended
 
</td></tr>
<tr><td>4</td><td>Lead wire insertion</td><td>1) If the leads clinching is too tight, the lead wire tend to be pulled excessively to cause lead wire breakage or cracking of the coating and quality degradation. Please adjust the clinching and provide sufficient preventive maintenance. Recommended capacitor layout is as following.

<table><tr><th></th><th>Not recommended</th><th>Recommended</th></tr><tr><td>Clinching</td><td>  </td><td>  </td></tr></table>
2) If capacitor leads are inserted into different pitch holes, it may induce excessive stress in the capacitor or outer resin to result in cracking, and it may degrade the quality.
When the lead pitch does not fit with the through hole on the pc board, please adjust the lead pitch so that the capacitor body would not receive excessive force.</td></tr>
</table>

No.	Process	Condition
5	Soldering	5-1. Flux selection Although highly-activated flux gives better solderability, substances which increase activity may also degrade the insulation of the capacitors. To avoid such degradation, it is recommended following. 1) It is recommended to use a mildly activated rosin flux (less than 0.1wt% chlorine). Do not use acidic flux is not recommended. 2) Excessive flux must be avoided. Please provide proper amount of flux. 3) When water-soluble flux is used, enough washing is necessary. 5-2. Recommended soldering profile by various methods Flow soldering  Manual soldering (Solder iron)  5-3. Avoiding thermal shock 1) Preheating condition | Soldering	Temp.(°C)
---	---
Wave soldering	ΔT≦150
Manual soldering	ΔT≦190	 2) Cooling condition Natural cooling using air is recommended. If the chips are dipped into a solvent for cleaning, the temperature difference(ΔT) must be less than 100°C. 5-4. Amount of solder In sufficient solder may detach the capacitor from the P.C.board. See bellow for example of solder amount. Adequate  Insufficient solder  Low robustness may cause contact failure or capacitor comes off the P.C.board.

<table>
<tr><th>No.</th><th>Process</th><th>Condition</th></tr>
<tr><td>5</td><td>Soldering</td><td>5-5. Solder repair by solder iron
Tip temperature of solder iron varies by its type, P.C.board material and solder land size. Higher the tip temperature, quick the operation is, but the heat shock may crack the capacitor. Following condition is recommended.
(Recommended solder iron condition)<table><tr><th>Temp. (°C)</th><th>Wattage (W)</th><th>Shape (mm)</th><th>Time (sec.)</th></tr><tr><td>350 MAX.</td><td>20 MAX.</td><td>φ3.0 MAX.</td><td>3 MAX.</td></tr></table></td></tr>
<tr><td>6</td><td>Cleaning</td><td>1) If an unsuitable cleaning fluid is used, flux residue or some foreign articles may stick to capacitor surface to deteriorate especially the insulation resistance.

2) If cleaning condition is not suitable, it may damage the capacitor.

2)-1. Insufficient washing
(1) Terminal electrodes may corrode by Halogen in the flux.
(2) Halogen in the flux may adhere on the surface of capacitor, and lower the insulation resistance.
(3) Water soluble flux has higher tendency to have above mentioned problems (1) and (2).

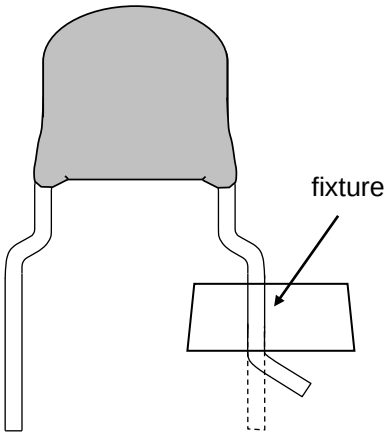
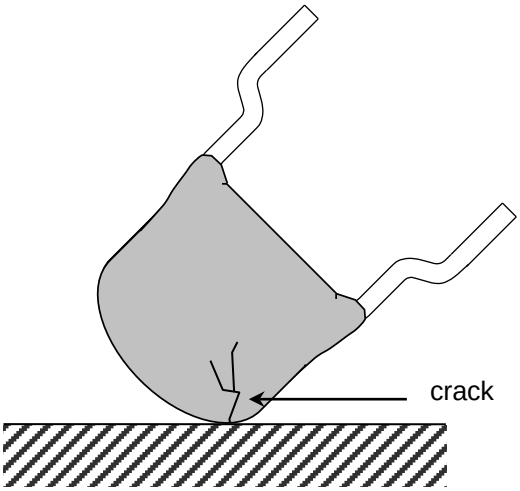
2)-2. Excessive washing
(1) Excessive washing way damage the coating material of coated capacitor and deteriorate it.
(2) When ultrasonic cleaning is used, excessively high ultrasonic energy output can affect the adhesion between the ceramic dielectric and the terminal electrodes. To avoid this, following is the recommended condition.

Power : 20W/ℓ max.
Frequency : 40kHz max.
Washing time : 5 minutes max.

2)-3. If the cleaning fluid is contaminated, density of Halogen increases, and it may bring the same result as insufficient cleaning.</td></tr>
<tr><td>7</td><td>Coating and molding of the P.C.board</td><td>1) When the P.C.board is coated, please verify the quality influence on the product.

2) Please verify carefully that there is no harmful decomposing or reaction gas emission during curing which may damage the capacitor.

3) Please verify the curing temperature.</td></tr>
</table>

No.	Process	Condition
8	Lead wire bending	During lead wire bending process, mechanical stress often concentrates in one part of capacitor body and it may damage the ceramic and the coating. Refer to following for bending the lead wire.  When bending the lead wire, hold the wire closer to the capacitor with a fixture so that the lead bending would not affect the capacitor body.
9	Handling of loose capacitor	If dropped the capacitor may crack. Once dropped do not use it. Especially, the large case sized capacitor is tendency to have cracks easily, so please handle with care. 
10	Capacitance aging	The capacitors (Class 2) have aging in the capacitance. They may not be used in precision time constant circuit. In case of the time constant circuit, the evaluation should be done well.
11	Estimated life and estimated failure rate of capacitors	The estimated life and the estimated failure rate depend on the temperature and the voltage. This can be calculated by the equation described in JEITA RCR-2335C Annex F(Informative) Calculation of the estimated lifetime and the estimated failure rate (Temperature acceleration : 3rd powered low, Voltage acceleration : 10degC law) The failure rate can be decreased by reducing the temperature and the voltage but they will not be guaranteed.

No.	Process	Condition
12	Caution during operation of equipment	1) A capacitor shall not be touched directly with bare hands during operation in order to avoid electric shock. Electric energy held by the capacitor may be discharged through the human body when touched with a bare hand. Even when the equipment is off, a capacitor may stay charged. The capacitor should be handled after being completely discharged using a resistor. 2) The terminals of a capacitor shall not be short-circuited by any accidental contact with a conductive object. A capacitor shall not be exposed to a conductive liquid such as an acid or alkali solution. A conductive object or liquid, such as acid and alkali, between the terminals may lead to the breakdown of a capacitor due to short circuit 3) Confirm that the environment to which the equipment will be exposed during transportation and operation meets the specified conditions. Do not to use the equipment in the following environments. (1) Environment where a capacitor is spattered with water or oil (2) Environment where a capacitor is exposed to direct sunlight (3) Environment where a capacitor is exposed to Ozone, ultraviolet rays or radiation (4) Environment where a capacitor exposed to corrosive gas(e.g. hydrogen sulfide, sulfur dioxide, chlorine. ammonia gas etc.) (5) Environment where a capacitor exposed to vibration or mechanical shock exceeding the specified limits. (6) Atmosphere change with causes condensation
13	Others ⚠ Caution	The product listed in this specification is intended for use in automotive applications under normal operation and usage conditions. The product is not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality requires a more stringent level of safety or reliability, or whose failure, malfunction or defect could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in this specification, please contact us. (1) Aerospace/Aviation equipment (2) Transportation equipment (electric trains, ships etc.) (3) Medical equipment (Excepting Pharmaceutical Affairs Law classification Class1,2) (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment. In addition, although the product listed in this specification is intended for use in automotive applications as described above, it is not prohibited to use in general electronic equipment, whose performance and/or quality doesn't require a more stringent level of safety or reliability, or whose failure, malfunction or defect could not cause serious damage to society, person or property. Therefore, the description of this caution will be applied, when the products are used in general electronic equipment under a normal operation and usage conditions.

11.TAPE PACKAGING SPECIFICATION

1. DIMENSION OF TAPING

Dimensions of FA1* type shall be according to Appendix 2.
Dimensions of FA2* type shall be according to Appendix 3.

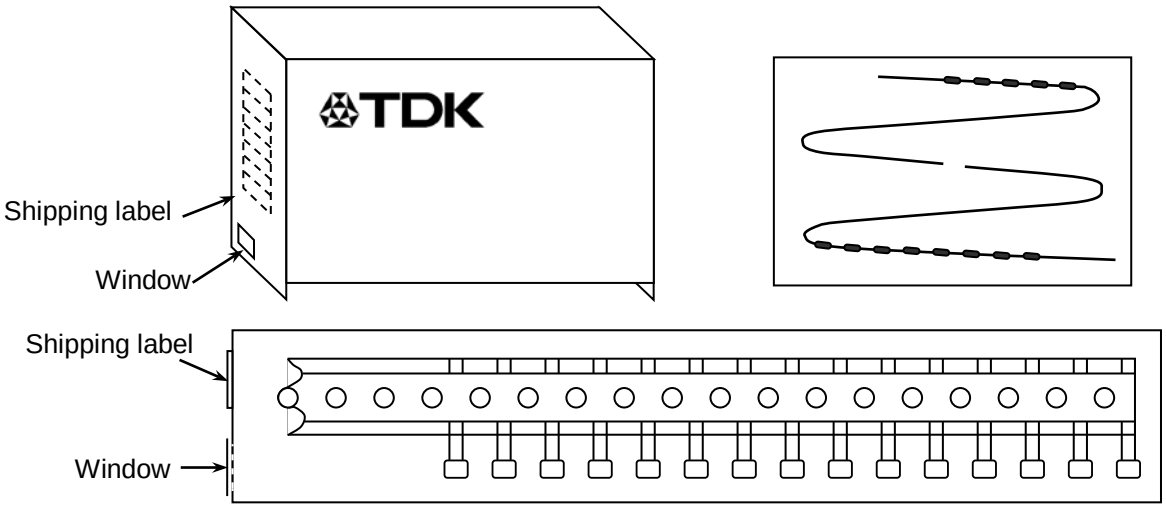
2. QUANTITY

Type	Parts quantity/box (pcs.)
FA18, FA28 FA14, FA24 FA16, FA26	2,000
FA11, FA20	1,500
FA22, FA23	1,000

3. PERFORMANCE SPECIFICATIONS

3-1. The missing of components shall be within consecutive 3pcs.
3-2. Empty part for min 3pcs shall be provided at the beginning and the end of taping.
3-3. Shipping label must be attached at the side of carton.
3-4. When pull the carrier tape for left side with keeping the head of capacitors to the direction of the above figure, adhesive tape shall be upper side.
3-5. Folded tape shall contain 25pcs. of components.

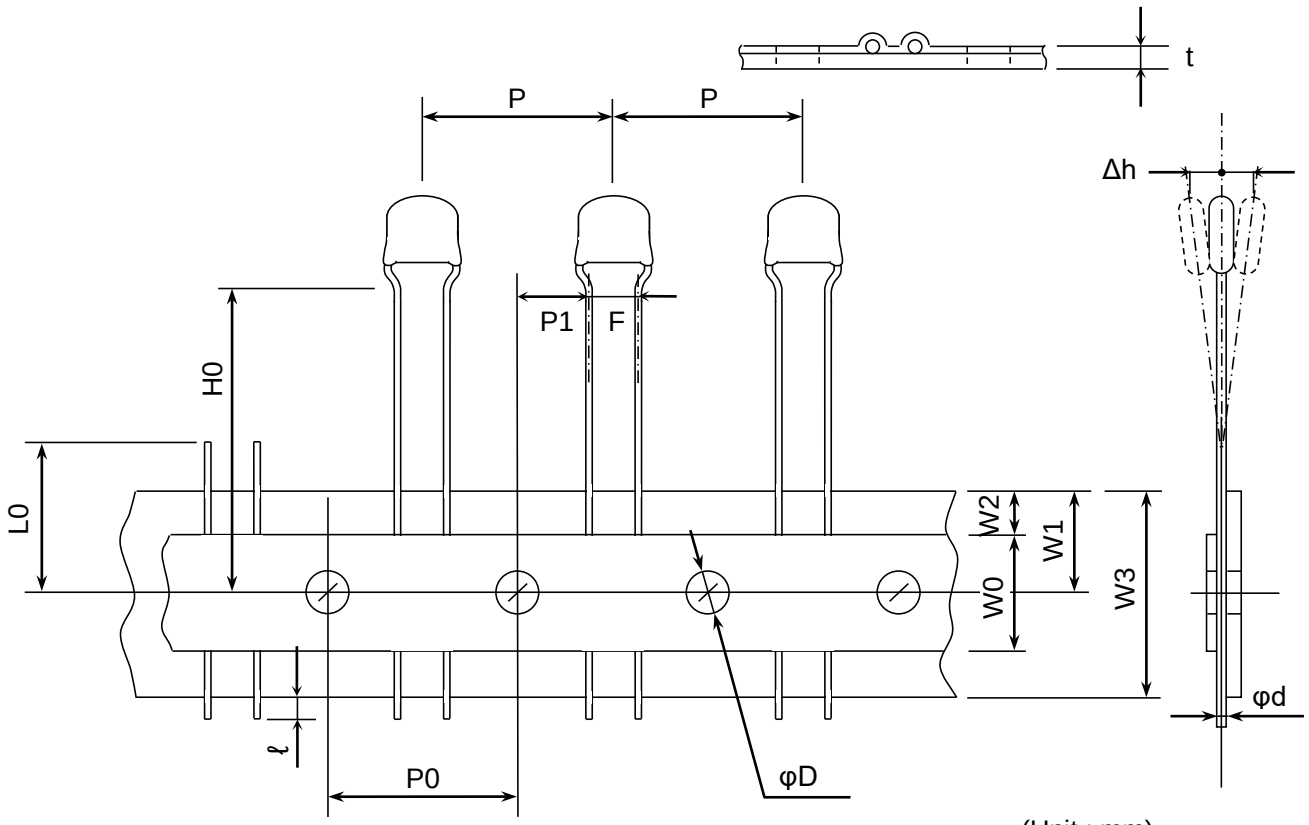
4. PACKAGING SPECIFICATION (Ammo pack)



4-1. Head of the capacitors shall face the window.
4-2. In case of FA22 and FA23 series, a stainless round steel is put in a hole of tape. Please remove a stainless round steel at the time of use.

Appendix 2 Taping dimensions

(FA18,FA14,FA16,FA11)



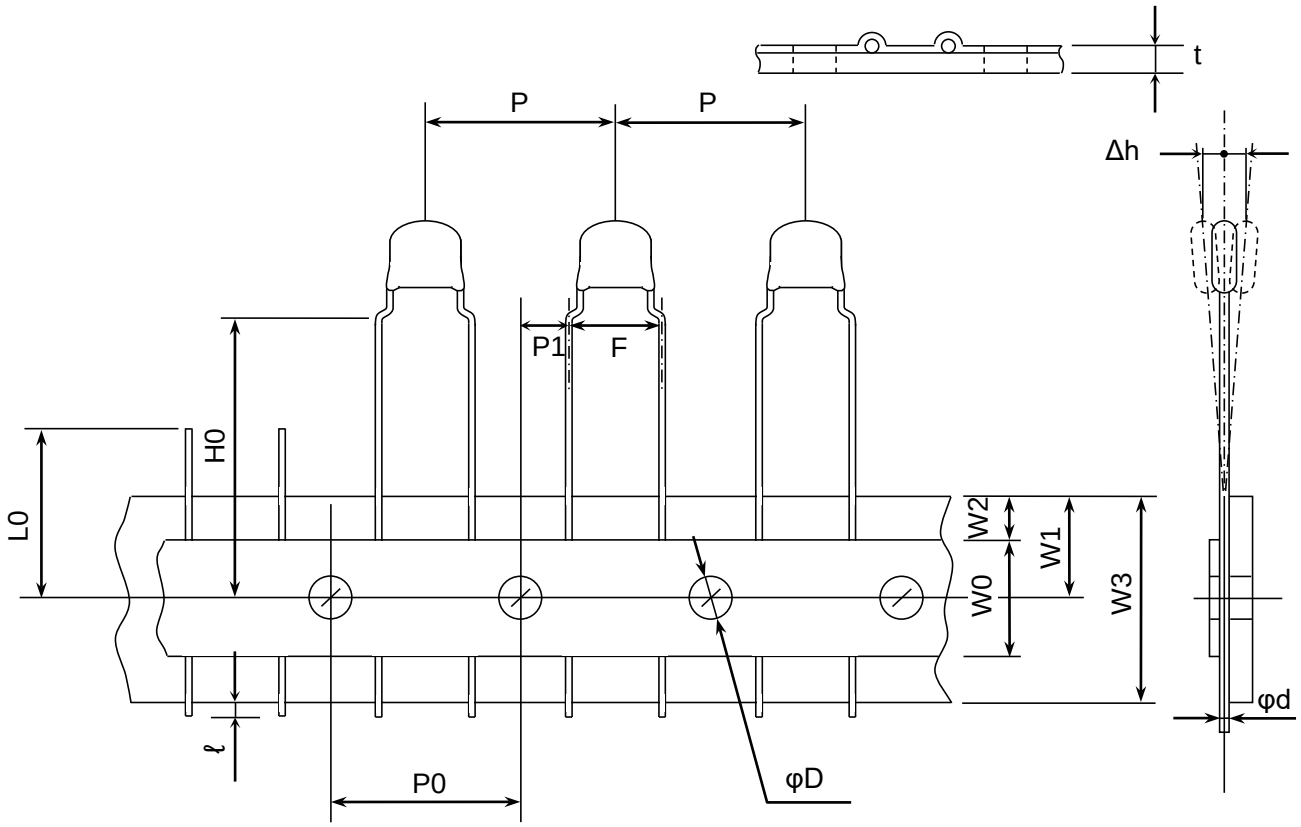
(Unit : mm)

Symbol	Dimensions	Note
P	(12.7)	
P0	(12.7)	
P1	(5.1)	
W0	12.0±1.0	
W1	9.0±0.5	
W2	3.0 max.	Adhesive tape shall not stick out from carrier tape.
W3	18.0+1.0,-0.5	
H0	16.0±0.8	
ℓ	1.0 max.	
t	0.6±0.2	
L0	11.0 max.	
F	2.5+0.5,-0.2	The measurement point is 1.5 to 2.0mm below the kink.
φd	φ0.5+0.1,-0.03	
φD	(φ4.0)	
Δh	(±2)	

( ) Reference value.

Appendix 3 Taping dimensions

(FA28,FA24,FA26,FA20,FA22,FA23)



(Unit : mm)

Symbol	Dimensions	Note
P	(12.7)	
P0	(12.7)	
P1	(3.85)	
W0	12.0±1.0	
W1	9.0±0.5	
W2	3.0 max.	Adhesive tape shall not stick out from carrier tape.
W3	18.0+1.0,-0.5	
H0	16.0±0.8	
ℓ	1.0 max.	
t	0.6±0.2	
L0	11.0 max.	
F	5.0+0.8,-0.2	The measurement point is 1.5 to 2.0mm below the kink.
φd	φ0.5+0.1,-0.03	
φD	(φ4.0)	
Δh	(±2)	

( ) Reference value.